22452

	125								
03	Hours	/	70	Marks	Seat No.				

- Instructions (1) All Questions are Compulsory.
 - (2) Answer each Section on same/spearate answer sheet.
 - (3) Answer each next main Question on a new page.
 - (4) Illustrate your answers with neat sketches wherever necessary.
 - (5) Figures to the right indicate full marks.
 - (6) Assume suitable data, if necessary.
 - (7) Mobile Phone, Pager and any other Electronic Communication devices are not permissible in Examination Hall.

Marks

1. Attempt any FIVE of the following:

10

- a) Classify Adhesives.
- b) State function of filling operation.
- c) Draw butt and lap joint.
- d) Define hot gas welding process.
- e) State any two applications of ultrasonic welding.
- f) State the need of solvent cleaning method.
- g) Enlist different methods of printing on plastics.

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 2. Attempt any THREE of the following: a) Elaborate Machining Techniques - i) Drilling ii) Threading b) Enlist Adhesive application methods. Explain any one. c) Explain shrink fitting and snap fitting. d) Describe the process of flocking with neat sketch. 3. Attempt any THREE of the following:	Marks
 i) Drilling ii) Threading b) Enlist Adhesive application methods. Explain any one. c) Explain shrink fitting and snap fitting. d) Describe the process of flocking with neat sketch. 	12
ii) Threadingb) Enlist Adhesive application methods. Explain any one.c) Explain shrink fitting and snap fitting.d) Describe the process of flocking with neat sketch.	
b) Enlist Adhesive application methods. Explain any one.c) Explain shrink fitting and snap fitting.d) Describe the process of flocking with neat sketch.	
c) Explain shrink fitting and snap fitting.d) Describe the process of flocking with neat sketch.	
d) Describe the process of flocking with neat sketch.	
3. Attempt any THREE of the following:	
or the following.	12
a) Define	
i) Ashing	
ii) Buffing	
iii) Polishing	
iv) Grinding	
b) Describe the process for preparation of substrate for adhesive application.	
c) Explain the process of hot plate welding.	
d) State any four advantages and applications of dip coating process.	
4. Attempt any <u>THREE</u> of the following:	12
a) Explain principle consideration of machining and tool geomet	ry.
b) Elaborate -	
i) Pressure Sensitive Adhesive	
ii) Hot Melt Adhesive.	
c) Identify and explain suitable welding technique for milk packaging pouches.	
d) Describe vaccum metallization technique used with plastics with neat diagram.	
e) Explain Electrostatic spraying method for application of coati with neat diagram.	ng

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5.		Attempt any <u>TWO</u> of the following:	12
	a)	Describe the process of solvent cementing by capillary method, state its any two applications.	
	b)	Describe the ultrasonic welding process.	

Attempt any TWO of the following:

film.

6.

12

a) With neat sketch explain screen printing process, state its any four applications.

c) Describe corona discharge treatment for surface treatment of

- b) Enlist various types of powder coating. Explain any one with its advantages.
- c) Describe solution blending and dry blending methods for powder coating manufacturing.